

# MMBD352LT1, MMBD353LT1, MMBD354LT1, MMBD355LT1

## Dual Hot Carrier Mixer Diodes

These devices are designed primarily for UHF mixer applications but are suitable also for use in detector and ultra-fast switching circuits.

### Features

- Very Low Capacitance – Less Than 1.0 pF @ Zero V
- Low Forward Voltage – 0.5 V (Typ) @  $I_F = 10$  mA
- Pb-Free Packages are Available

### MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	$V_R$	7.0	$V_{CC}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	225 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	$^\circ\text{C/W}$
Total Device Dissipation Alumina Substrate, (Note 2) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	300 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	$^\circ\text{C/W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-5 = 1.0 x 0.75 x 0.062 in.
2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (EACH DIODE)

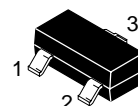
Rating	Symbol	Min	Max	Unit
Forward Voltage ( $I_F = 10$ mAdc)	$V_F$	–	0.60	V
Reverse Voltage Leakage Current (Note 3) ( $V_R = 3.0$ V) ( $V_R = 7.0$ V)	$I_R$	–	0.25 10	$V_{CC}$
Capacitance ( $V_R = 0$ V, $f = 1.0$ MHz)	C	–	1.0	pF

3. For each individual diode while the second diode is unbiased.

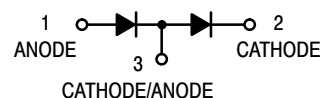


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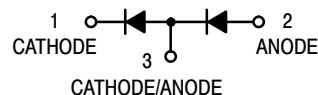
<http://onsemi.com>



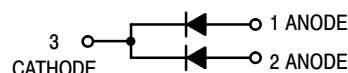
SOT-23 (TO-236)  
CASE 318



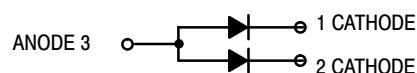
MMBD352LT1  
STYLE 11



MMBD353LT1  
STYLE 19

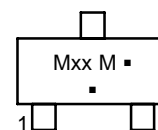


MMBD354LT1  
STYLE 9



MMBD355LT1  
STYLE 12

### MARKING DIAGRAM



Mxx = Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)  
\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

### ORDERING INFORMATION

See detailed ordering, marking, and shipping information in the package dimensions section on page 2 of this data sheet.

# MMBD352LT1, MMBD353LT1, MMBD354LT1, MMBD355LT1

## TYPICAL CHARACTERISTICS

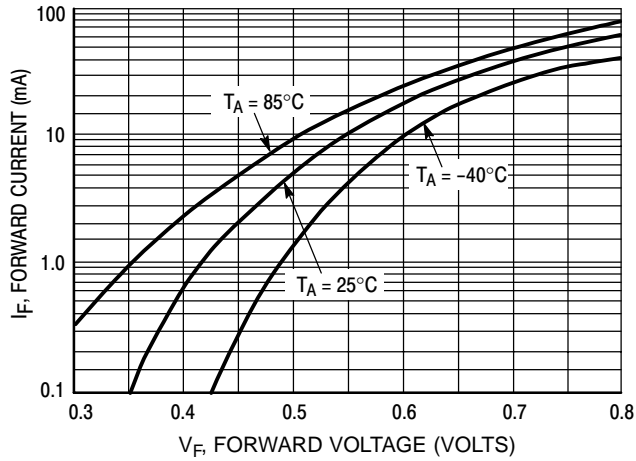


Figure 1. Forward Voltage

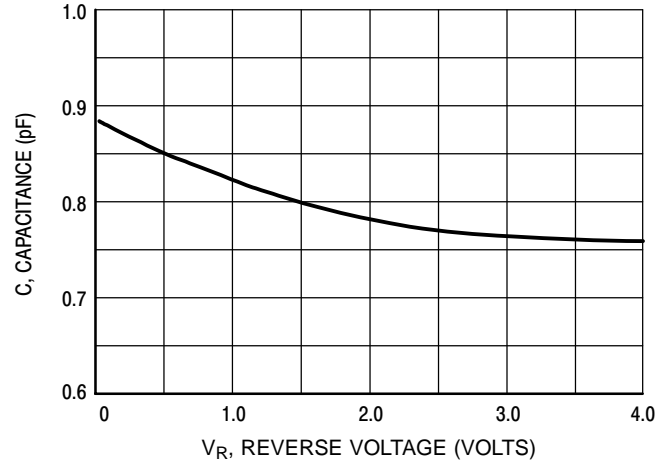


Figure 2. Capacitance

## ORDERING INFORMATION

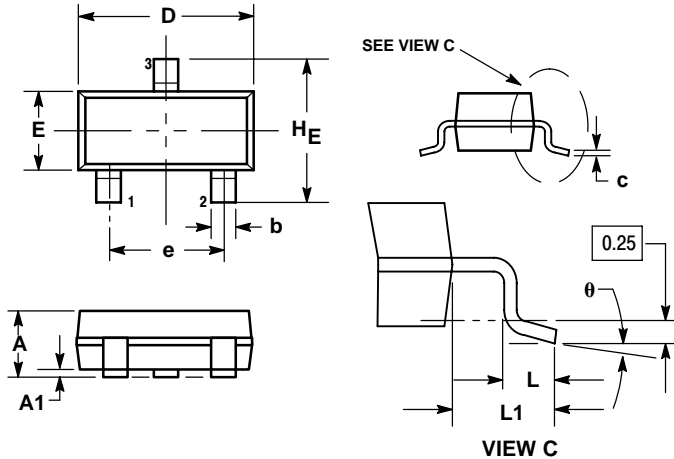
Device	Marking	Package	Shipping <sup>†</sup>
MMBD352LT1	M5G	SOT-23	3,000 Units / Tape & Reel
MMBD352LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD352LT3		SOT-23	10,000 Units / Tape & Reel
MMBD352LT3G		SOT-23 (Pb-Free)	10,000 Units / Tape & Reel
MMBD353LT1	M4F	SOT-23	3,000 Units / Tape & Reel
MMBD353LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD353LT3		SOT-23	10,000 Units / Tape & Reel
MMBD353LT3G		SOT-23 (Pb-Free)	10,000 Units / Tape & Reel
MMBD354LT1	M6H	SOT-23	3,000 Units / Tape & Reel
MMBD354LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel
MMBD355LT1	MJ1	SOT-23	3,000 Units / Tape & Reel
MMBD355LT1G		SOT-23 (Pb-Free)	3,000 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MMBD352LT1, MMBD353LT1, MMBD354LT1, MMBD355LT1

## PACKAGE DIMENSIONS

### SOT-23 (TO-236) CASE 318-08 ISSUE AN



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

#### MMBD352LT1

STYLE 11:

- PIN 1. ANODE
- 2. CATHODE
- 3. CATHODE-ANODE

#### MMBD353LT1

STYLE 19:

- PIN 1. CATHODE
- 2. ANODE
- 3. CATHODE-ANODE

#### MMBD354LT1

STYLE 9:

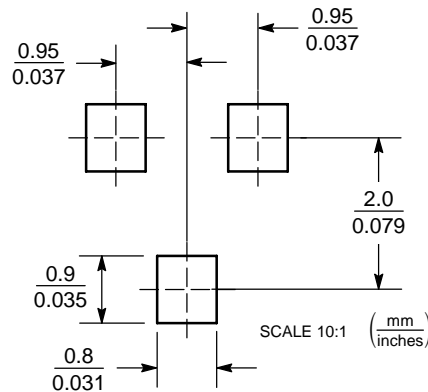
- PIN 1. ANODE
- 2. ANODE
- 3. CATHODE

#### MMBD355LT1

STYLE 12:

- PIN 1. CATHODE
- 2. CATHODE
- 3. ANODE

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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